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# HMC215LP4 / 215LP4E

# GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz



#### **Typical Applications**

The HMC215LP4 / HMC215LP4E is ideal for Wireless Infrastructure Applications:

- PCS / 3G Infrastructure
- Base Stations & Repeaters
- WiMAX & WiBro
- ISM & Fixed Wireless

#### **Features**

Input IP3: +25 dBm

Low Input LO Drive: +2 to +6 dBm

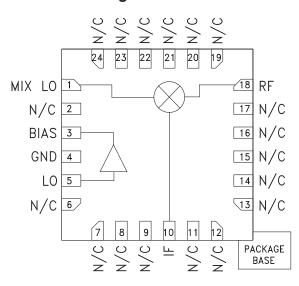
High LO to RF Isolation: 32 dB

Low Conversion Loss: 8 dB

Single Positive Supply: +5V @ 56 mA

24 Lead Ceramic 4x4mm SMT Package: 16mm²

#### **Functional Diagram**



#### **General Description**

The HMC215LP4 & HMC215LP4E are high linearity, double-balanced converter ICs that operate from 1.7 to 4.0 GHz and deliver a +25 dBm input third order intercept point. The LO amplifier output and high dynamic range mixer input are positioned so that an external LO filter can be placed in series be-tween them. The converter provides 32 dB of LO to RF isolation and is ideal for upconverter and down-converter applications. The IC operates from a single +5V supply consuming 56 mA of current and accepts a LO drive level of 2 to 6 dBm. The design requires no external baluns and supports IF frequencies between DC and 1 GHz. The HMC215LP4(E) is pin for pin compatible with the HMC552LP4(E), which operates from 1.6 to 3.0 GHz.

## Electrical Specifications, $T_{\Delta} = +25^{\circ}\text{C}$ , LO = +4 dBm, Vcc = +5V, IF = 100 MHz\*

| Parameter                      | Min.   | Тур.      | Max. | Units |
|--------------------------------|--------|-----------|------|-------|
| Frequency Range, RF, LO        |        | 1.7 - 4.0 |      | GHz   |
| Frequency Range, IF            |        | DC - 1.0  |      | GHz   |
| Conversion Loss                |        | 8.0       | 11   | dB    |
| Noise Figure (SSB)             |        | 8.5       |      | dB    |
| LO to RF Isolation             | 23     | 32        |      | dB    |
| LO to IF Isolation             | 10     | 20        |      | dB    |
| IP3 (Input)                    |        | 25        |      | dBm   |
| 1 dB Compression (Input)       |        | 17        |      | dBm   |
| LO Drive Input Level (Typical) | 2 to 6 |           | dBm  |       |
| Supply Current (Icc)           |        | 56        | 60   | mA    |

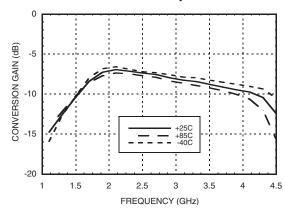
<sup>\*</sup>Unless otherwise noted, all measurements performed as a downconverter, with low side LO and configured as shown in application circuit.



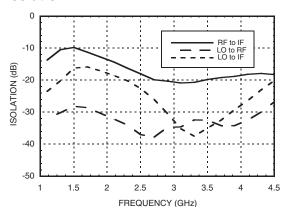


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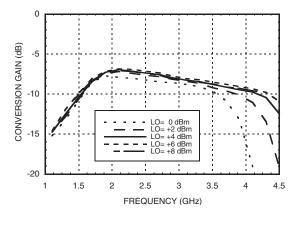
#### Conversion Gain vs. Temperature



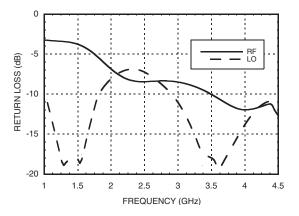
#### Isolation



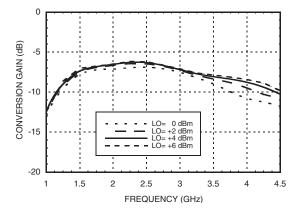
#### Conversion Gain vs. LO Drive



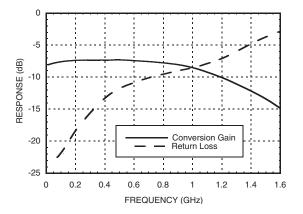
**Return Loss** 



# Upconverter Performance Conversion Gain vs. LO Drive



#### IF Bandwidth

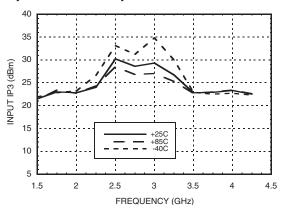




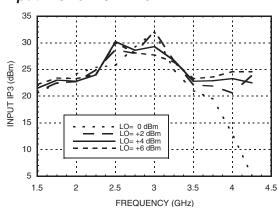


# GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz

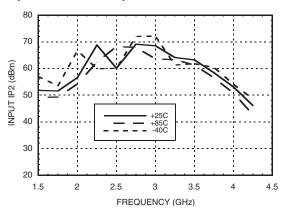
#### Input IP3 vs. Temperature



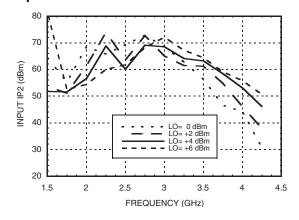
#### Input IP3 vs. LO Drive



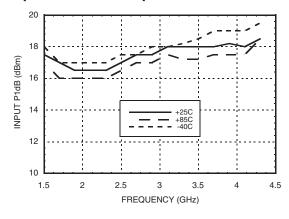
#### Input IP2 vs. Temperature



#### Input IP2 vs. LO Drive



#### Input P1dB vs. Temperature



#### **MxN Spurious @ IF Port**

|     | nLO |     |     |     |     |
|-----|-----|-----|-----|-----|-----|
| mRF | 0   | 1   | 2   | 3   | 4   |
| 0   | xx  | -4  | 10  | 14  | 32  |
| 1   | 5   | 0   | 22  | 37  | 49  |
| 2   | 78  | 66  | 60  | 63  | 93  |
| 3   | 83  | 97  | 92  | 80  | 80  |
| 4   | 103 | 101 | 106 | 105 | 101 |

RF Freq. = 1.9 GHz @ -10 dBm

LO Freq. = 1.8 GHz @ 4 dBm

All values in dBc relative to the IF power level.



# HMC215LP4 / 215LP4E

# GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz



#### Harmonics of LO

|   | nLO Spur @ RF Port |    |    |    |
|---|--------------------|----|----|----|
| LO Freq. (GHz)  | 1                  | 2  | 3  | 4  |
| 1.0   | 32                 | 40 | 27 | 40 |
| 1.4   | 28                 | 19 | 25 | 30 |
| 1.8   | 29                 | 16 | 30 | 42 |
| 2.2   | 33                 | 18 | 27 | 44 |
| 2.6   | 35                 | 23 | 34 | 41 |
| 3.0   | 34                 | 20 | 41 | 44 |
| LO = 4 dBm<br>All values in dBc below input LO level measured at RF port. |                    |    |    |    |



### **Typical Supply Current**

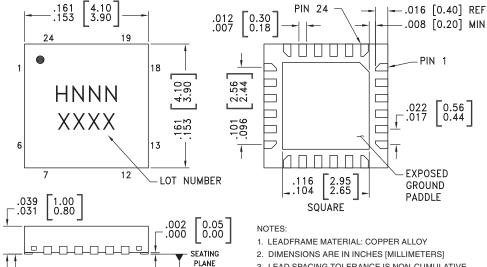
| Vcc  | Icc (mA) |
|------|----------|
| +5.0 | 56 mA    |

#### **Absolute Maximum Ratings**

| RF / IF Input (Vcc= +5V)                                      | +22 dBm       |
|---|---------------|
| LO Drive (Vcc= +5V)   | +10 dBm       |
| BIAS  | +7 Vdc        |
| Junction Temperature  | 150°C         |
| Continuous Pdiss (T = 85°C)<br>(derate 5.21 mW/°C above 85°C) | 0.339 W       |
| Thermal Resistance (junction to ground paddle)                | 192 °C/W      |
| Storage Temperature   | -65 to +150°C |
| Operating Temperature   | -40 to +85°C  |

#### **Outline Drawing**

#### BOTTOM VIEW



-C-

- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURB HEIGHT SHALL BE 0.05mm MAXIMUM
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

## Package Information

.003[0.08] C

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating | Package Marking [3] |
|-------------|--|---------------|------------|---------------------|
| HMC215LP4   | Low Stress Injection Molded Plastic                | Sn/Pb Solder  | MSL1 [1]   | H215<br>XXXX        |
| HMC215LP4E  | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2]   | <u>H215</u><br>XXXX |

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



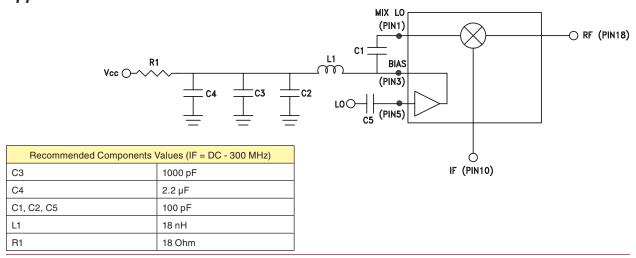


# GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz

#### **Pin Descriptions**

| Pin Number                    | Function | Description  | Interface Schematic |
|-------------------------------|----------|--|---------------------|
| 1                             | MIX LO   | This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.  | MIX LOO             |
| 2, 6 - 9,<br>11 - 17, 19 - 24 | N/C      | No connection. These pins may be connected to RF ground.  Performance will not be affected.  |                     |
| 3                             | BIAS     | Power supply for the LO amplifier. Three external bypass capacitors are recommended for optimum performance, as illustrated in the application circuit.  | BIASO               |
| 4                             | GND      | Backside of package has exposed metal ground paddle that must also be connected to ground.   | ĢGND<br><u>=</u>    |
| 5                             | LO       | This pin is DC coupled and matched to 50 Ohms from 1.7 to 4.0 GHz. An off chip DC blocking capacitor is required.  | L00                 |
| 10                            | IF       | This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 18 mA of current or die non-function and possible die failure will result. | IF O-M              |
| 18                            | RF       | This pin is DC coupled and matched to 50 Ohms.   | RF O                |

## **Application Circuit**

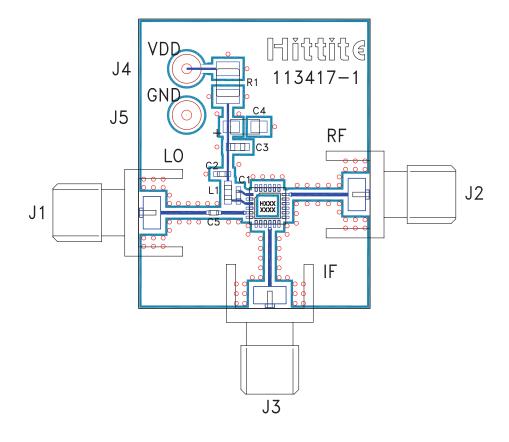






# GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 115820 [1]

| Item       | Description                         |
|------------|-------------------------------------|
| J1 - J3    | PCB Mount SMA RF Connector          |
| J4, J5     | DC Pin                              |
| C1, C2, C5 | 100 pF Chip Capacitor, 0402 Pkg.    |
| С3         | 1000 pF Chip Capacitor, 0603 Pkg.   |
| C4         | 2.2 µF Capacitor, Tantalum          |
| L1         | 18 nH Chip Inductor, 0603 Pkg.      |
| R1         | 18 Ohm Resistor, 1210 1/8 watt Pkg. |
| U1         | HMC215LP4 / HMC215LP4E              |
| PCB [2]    | 113417 Evaluation Board             |

[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350

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